

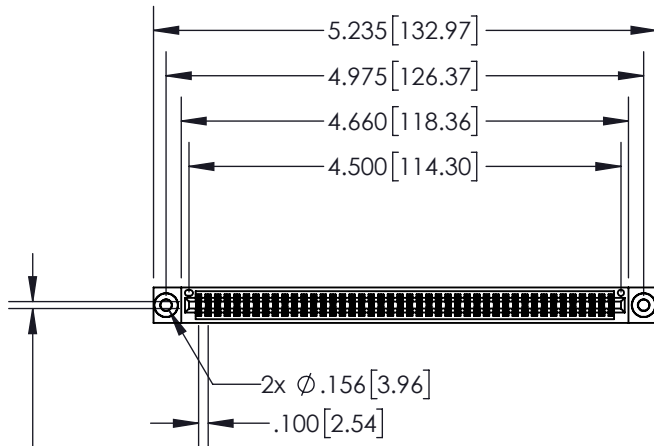
**Contact Dimensions:**  
**560-Extender Board Bend (Code 523 Contacts)**  
 See Sheet 2 for Contact Code 555, 556, 558, 559, 560 Dimensions

THIS IS A C.A.D. GENERATED DRAWING  
 DO NOT MAKE MANUAL REVISIONS TO MASTER

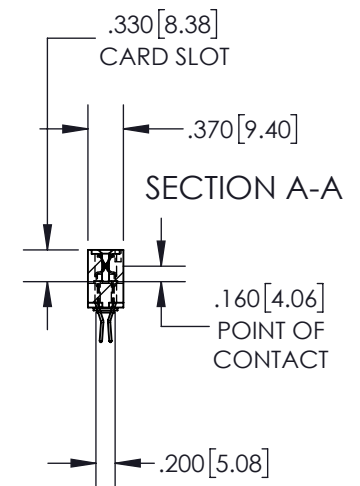
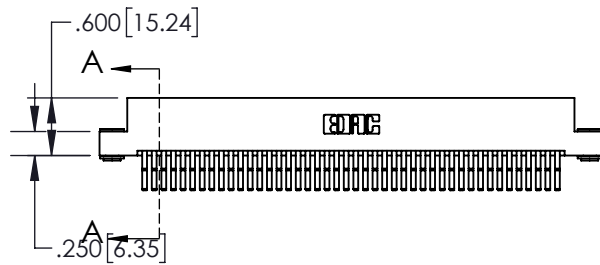


ISSUE NUMBER

ORIGINAL



CARD SLOT ACCEPTS  
 .054" [1.37] TO .070" [1.78]  
 THICK PCB



- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL; COPPER TIN ALLOY
- CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

**845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR**  
**PART NUMBER: 895-088-560-203**

ACAD REFERENCE NO. 845-ENG-MASTER

DRAWN: R.STA.MONICA DATE MAY.16/2017

CHECKED: DATE:

SCALE: 1:2 SHEET 1 OF 2

DRAWING NUMBER 845-ENG-MASTER ISSUE 1

**EDAC** EDAC INC  
 TORONTO, ONTARIO  
 CANADA  
 YOUR CONNECTION TO QUALITY & SERVICE

THESE DRAWINGS AND SPECIFICATIONS  
 ARE THE PROPERTY OF EDAC INC. AND  
 SHALL NOT BE REPRODUCED, OR COPIED  
 OR USED AS THE BASIS FOR THE  
 MANUFACTURE OR SALE OF APPARATUS  
 WITHOUT WRITTEN PERMISSION.

THIS IS A C.A.D. GENERATED DRAWING  
DO NOT MAKE MANUAL REVISIONS TO MASTER.



ISSUE NUMBER

ORIGINAL



**Contact Code 555**



**Contact Code 556**



**Contact Code 558**



**Contact Code 559**



**Contact Code 560**

- INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0
- DAP MATERIAL AVAILABLE UPON REQUEST
- CONTACT MATERIAL: COPPER ALLOY
- CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

**845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR  
CONTACT CODE 555,556,558,559,560 DIMENSIONS**



THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF EDAC INC. AND SHALL NOT BE REPRODUCED, OR COPIED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS WITHOUT WRITTEN PERMISSION.

ACAD REFERENCE NO. 845-ENG-MASTER	
DRAWN: R.STA.MONICA	DATE: MAY.16/2017
CHECKED:	DATE:
SCALE: 1:1	SHEET 2 OF 2
DRAWING NUMBER 845-ENG-MASTER	ISSUE 1